Complementary Plastic Silicon Power Transistors

These devices are designed for lower power audio amplifier and low current, high–speed switching applications.

Features

- Low Collector–Emitter Sustaining Voltage V_{CEO(sus)} 60 Vdc (Min)
- High Current–Gain Bandwidth Product –

 $f_T = 50 \text{ MHz (Min)} @ I_C = 100 \text{ mAdc}$

- Collector–Emitter Saturation Voltage Specified at 0.5, 1.0, 2.0 and 4.0 Adc
- Pb-Free Packages are Available*



Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V _{CEO}	60	Vdc
Collector-Base Voltage	V _{CBO}	80	Vdc
Emitter Base Voltage	V _{EBO}	6.0	Vdc
Collector Current – Continuous – Peak	I _C	4.0 8.0	Adc
Base Current – Continuous	I _B	1.0	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	15 0.12	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	8.34	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



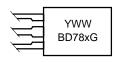
ON Semiconductor®

http://onsemi.com

4 AMPERES POWER TRANSISTORS COMPLEMENTARY SILICON 60 VOLTS, 15 WATTS



MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
BD787	TO-225	500 Units/Box
BD787G	TO-225 (Pb-Free)	500 Units/Box
BD788	TO-225	500 Units/Box
BD788G	TO-225 (Pb-Free)	500 Units/Box

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS* ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (Note 1) (I _C = 10 mAdc, I _B = 0)		V _{CEO(sus)}	60	_	Vdc
Collector Cutoff Current $(V_{CE} = 20 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 30 \text{ Vdc}, I_B = 0)$		ICEO	-	100	μAdc
Collector Cutoff Current $(V_{CE} = 80 \text{ Vdc}, V_{BE(off)} = 1.5 \text{ Vdc})$ $(V_{CE} = 40 \text{ Vdc}, V_{BE(off)} = 1.5 \text{ Vdc}, T_C = 125^{\circ}\text{C})$		I _{CEX}	_ _	1.0 0.1	μAdc mAdc
Emitter Cutoff Current $(V_{EB} = 6.0 \text{ Vdc}, I_C = 0)$		I _{EBO}	_	1.0	μAdc
ON CHARACTERISTICS (Note 1)		•			•
$ \begin{array}{l} \text{DC Current Gain} \\ \text{(I}_{\text{C}} = 200 \text{ mAdc, V}_{\text{CE}} = 3.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 1.0 \text{ Adc, V}_{\text{CE}} = 3.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 2.0 \text{ Adc, V}_{\text{CE}} = 3.0 \text{ Vdc)} \\ \text{(I}_{\text{C}} = 4.0 \text{ Adc, V}_{\text{CE}} = 3.0 \text{ Vdc)} \end{array} $		h _{FE}	40 25 20 5.0	250 - - -	,1
		V _{CE(sat)}	- - -	0.4 0.6 0.8 2.5	Vdc
Base–Emitter Saturation Voltage (I _C = 2.0 Adc, I _B = 200 mAdc)		V _{BE(sat)}	_	2.0	Vdc
Base–Emitter On Voltage (I _C = 2.0 Adc, V _{CE} = 3.0 Vdc)		V _{BE(on)}	-	1.8	Vdc
DYNAMIC CHARACTERISTICS					
Current–Gain – Bandwidth Product (I _C = 100 mAdc, V _{CE} = 10 Vdc, f = 10 MHz)		f _T	50	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _C = 0) (f = 0.1 MHz)	BD787 BD788	C _{ob}	_ _	50 70	pF
Small–Signal Current Gain (I _C = 200 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz) *Indicates IEDEC Registered Data		h _{fe}	10	-	-

^{*}Indicates JEDEC Registered Data 1. Pulse Test; Pulse Width $\leq 300~\mu s$, Duty Cycle $\leq 2.0\%$.

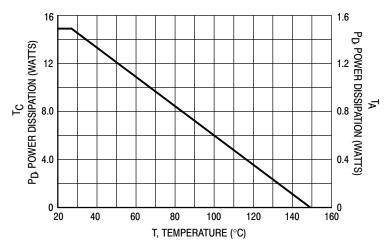


Figure 1. Power Derating

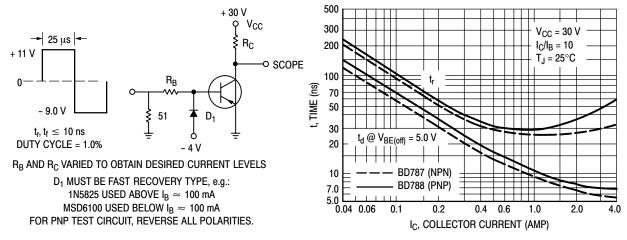


Figure 2. Switching Time Test Circuit

Figure 3. Turn-On Time

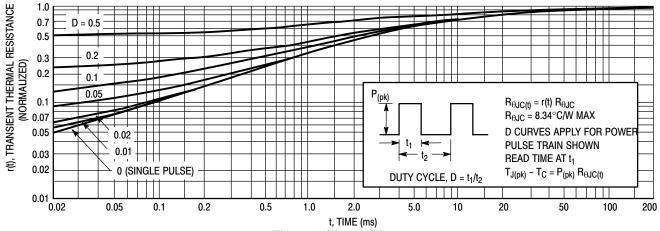


Figure 4. Thermal Response

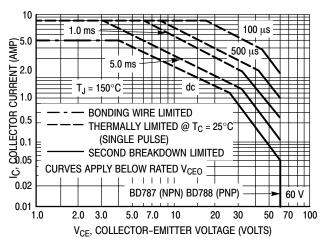


Figure 5. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150^{\circ} C$: T_C is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ} C$, $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

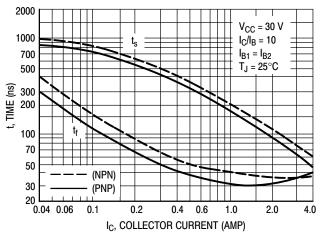


Figure 6. Turn-Off Time

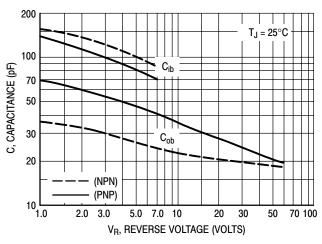


Figure 7. Capacitance

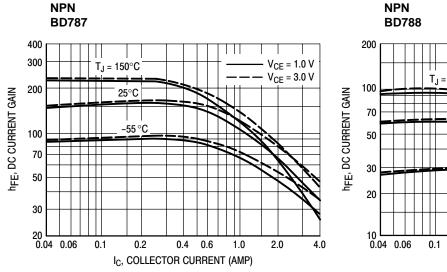
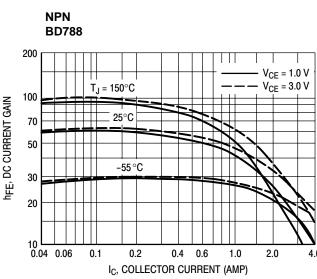


Figure 8. DC Current Gain



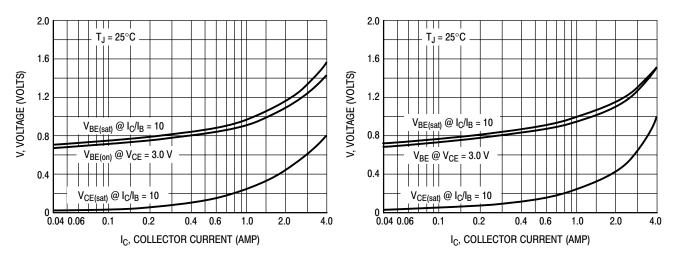


Figure 9. "On" Voltages

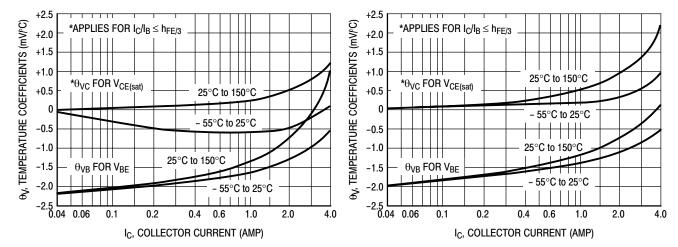
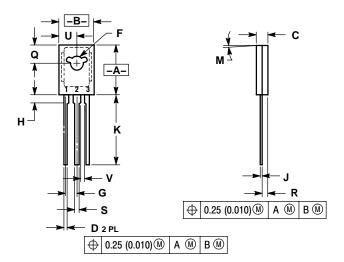


Figure 10. Temperature Coefficients

PACKAGE DIMENSIONS

TO-225 CASE 77-09 ISSUE Z



NOTES.

- DIMENSIONING AND TOLERANCING PER ANSI
 VIA 5M 1982
 - . CONTROLLING DIMENSION: INCH.
- 077-01 THRU -08 OBSOLETE, NEW STANDARD 077-09.

	INC	INCHES MILLIMETE		
DIM	MIN	MAX	MIN	MAX
Α	0.425	0.435	10.80	11.04
В	0.295	0.305	7.50	7.74
С	0.095	0.105	2.42	2.66
D	0.020	0.026	0.51	0.66
F	0.115	0.130	2.93	3.30
G	0.094	0.094 BSC		BSC
Н	0.050	0.095	1.27	2.41
J	0.015	0.025	0.39	0.63
K	0.575	0.655	14.61	16.63
M	5° TYP		5° TYP	
Q	0.148	0.158	3.76	4.01
R	0.045	0.065	1.15	1.65
S	0.025	0.035	0.64	0.88
U	0.145	0.155	3.69	3.93
v	0.040		1.02	

STYLE 1:

PIN 1. EMITTER

2. COLLECTOR

3 BASE

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